

PCT

REQUEST

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International Application No.				
International Filing Date				
Name of receiving Office and "PCT International Application"				

The undersigned requests that the present international application be processed according to the Patent Cooperation Treaty.	Name of receiving Office and "PCT International Application"					
	Applicant's or agent's ti (if desired) (12 characters n					
Box No. 1 TITLE OF INVENTION						
ABSOLUTE HUMIDITY SENSOR						
Box No. II APPLICANT						
Name and address: (Family name followed by given name: for a legal entity, full official designation. The address must include postal code and name of country. The country of the address indicated in this Box is the applicant's State (that is, country) of residence if no State of residence is indicated below.)						
LG ELECTRONICS INC.		Telephone No. (82) (02) 3777-7093				
20, Yoido-dong, Youngdungpo-gu,		Facsimile No. (82) (02) 3777-5151				
Seoul, 150-010, Republic of Korea		Teleprinter No.				
State (that is, country) of nationality:	State (that is, country) of	f residence: KR				
This person is applicant for the purposes of: all designated the United S		e United States America only the States indicated in the Supplemental Box				
Box No. III FURTHER APPLICANT(S) AND/OR (FURT	HER) INVENTOR(S)					
Name and address: (Family name followed by given name: for a designation. The address must include postal code and name of country, address indicated in this Box is the applicant's State (that is, country, of residence is indicated below.)		This person is:				
LEE, Don Hee		x applicant and inventor				
Samik APT., 1-1109, 572, Pisan-dong,						
Tongan-gu, Anyang-shi, Kyonggi-do,		inventor only (If this check-box is marked, do not fill in below.)				
431-050, Republic of Korea						
State (that is, country) of nationality:	State (that is, country) of	residence: KR				
This person is applicant all designated for the purposes of:		United States the States indicated in America only the Supplemental Box				
X Further applicants and/or (further) inventors are indicated or	n a continuation sheet.					
Box No. IV AGENT OR COMMON REPRESENTATIVE;	OR ADDRESS FOR C	ORRESPONDENCE				
The person identified below is hereby/has been appointed to act of of the applicant(s) before the competent International Authorities a	n behalf X ag	gent common representative				
Name and address: (Family name followed by given name; for a designation. The address must include postal con	legal entity, full official de and name of country.)	Telephone No. (82) (02) 3453-6701				
KIM, Yong In, KANG, Yong Bok		Facsimile No.				
15th Floor, Yo Sam Bldg., 648-23	(82) (02) 557-3404					
Yeoksam-dong, Kangnam-ku,	Teleprinter No.					
Seoul, 135-080, Republic of Korea						
Address for correspondence: Mark this check-box where no	agent or common representation	ntative is/has been appointed and the ld be sent.				

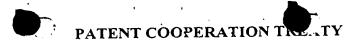
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Continuation of Box No. III FURTHER APPLICANT(S) AND/OR (FURTHER) INVENTOR(S)							
If none of the following sub-boxes is used, this sheet should not be included in the request.							
Name and address: (Family name followed by given name: for a lidesignation. The address must include postal code and name of cour address indicated in this Box is the applicant's State (that is, country) of residence is indicated below.) BU, Jong Uk Hanjin APT., 701-1303, Chongja-dong, Pundang-gu, Songnam-shi, Kyonggi-do, 463-010, Republic of Korea							
State (that is, country) of nationality:	State (that is, country) of residence:						
This person is applicant all designated the United States all designated the United States	States except						
Name and address: (Family name followed by given name: for a la designation. The address must include postal code and name of coun address indicated in this Box is the applicant's State (that is, country) of residence is indicated below.)	This person is: applicant only applicant and inventor inventor only (If this check-box is marked, do not fill in below.)						
State (that is, country) of nationality:	State (that is, country) of residence:						
This person is applicant all designated all designated for the purposes of: States the United State	States except the United States the States indicated in the Supplemental Box						
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The following designations are hereby made under Rule 4.9(a) (murk the applicable check-batter; at least one must be marked): Regional Patter. APT ARPO Patent: CH Ghana, GM Gambia, KE Kenya. LS Lesotho, MM Malawi, SD Sudan, S. Sierra Loone, SZ swaziland PAT ARPO Patent: CH Ghana, CM Gambia, KE Kenya. LS Lesotho, MM Malawi, SD Sudan, S. Sierra Loone, SZ swaziland PAT ARPO Patent: CH Ghana, CM Gambia, KE Kenya. LS Lesotho, MM Malawi, SD Sudan, S. Sierra Loone, SZ swaziland Protocol and of the PCT SE A Lorrasian Patent: AM Armenia, AZ Archbijan, BY Belanus, KG Kyrrgystan, KZ Kazakhstan, MD Republic of Moldowa Republic of the PCT SE P Lorropean Patent: AT Avstria, BE Begjum, CH and LI Switzerland, and Liebensainer, CY, Cypus, DE Germany DK Domnack, ES Spain, FI Finland, FR France, GB Unstanding other State which is a Contracting State of the European Patent Characterion and of the PCT. A CH Common Patent: A State of Characterion and Characterion and of the PCT. A CH Common Patent A State of Characterion and Characterion and of the PCT. A CH Characterion and Characterio	Bd	Bux No.V DESIGNATION OF STATES									
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National Patent (if other kind of protection or reatment desired, specify on dotred line): A			GA Gabon, GN Guinea, GW Guinea-Bissau, ML Man, other State which is a member State of OAPI and a Contra specify on dotted line)	ctin	g State	e of the PCT (if other kind of protection or treatment desired.					
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Sheet No. ...4...

Box No. VI PRIORITY C	LAIM		Further priority claims are indicated in the Supplemental Bo				
Filing date Number			Where earlier application is:				
of earlier application (day/month/year)	of earlier applic	ation	national application: country	regional application:* regional Office	international application		
item (1) 13, December 1999 (13, 12,1999)	1999-5719	96	S KR				
item (2)							
item (3)							
The receiving Office is req of the earlier application(s purposes of the present into	s) (only if the eartie ernational applicat	er appud ion is th	e receiving Office) identif	ied above as item(s):			
Where the earlier application is a Convention for the Protection of Inc.	an ARIPO application dustrial Property for	i, it is mo	indatory to indicate in the Si at earlier application was file	applemental Box at least on the (Rule 4.10(b)(ii)). See Su	e country party to the Paris upplemental Box.		
Box No. VII INTERNATIO	NAL SEARCHIN	G AUT	HORITY				
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Box No. VIII CHECK LIST	1	F FILI	NG				
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Figure of the drawings which should accompany the abstract:	2A	inte	nguage of filing of the mational application:	English			
Box No. IX SIGNATURE Of Next to each signature, indicate the name	OF APPLICANT	OR AG	enacity in which the person sign	us (if such capacity is not obvio	ous from reading the request).		
Next to each signature, indicate the nam	ie of the person signing	ana me c	apacity in which the posteriors.	,			
KIM, You	ng In		(Seal)				
KANG, Yong Bok (Seal)							
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PCT

INTERNATIONAL SEARCH REPORT

(PCT Article 18 and Rules 43 and 44)

Applicant's or agent's file reference	FOR FURTHER	see Notification of Transmitt	al of International Search Report					
AZ00-0175WO	ACTION	(Form PCT/ISA/220) as well	as, where applicable, item 5 below.					
International application No.	International filing da	te (day/month/year)	(Earliest) Priority Date (day/month/year)					
PCT/KR 00/01440	12 December	2000 (12.12.2000)	13 December 1999 (13.12.1999)					
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Telephone No. 1/53424/347

CLASSIFICATION OF SUBJECT MATTER IPC⁷: G01N 27/12 According to International Patent Classification (IPC) or to both national classification and IPC FIELDS SEARCHED Minimum documentation searched (classification system followed by classification symbols) IPC⁷: G01N 27/12, G01N 27/22, G01N 27/18 Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Electronic data base consulted during the international search (name of data base and, where practicable, search terms used) WPI C. DOCUMENTS CONSIDERED TO BE RELEVANT Citation of document, with indication, where appropriate, of the relevant passages Relevant to claim No. X GB 2194845 A (SHARP) 16 March 1988 (16.03.88) 1-3,5-7 the whole document. 4,8,9 Υ Υ WO 91/03734 A1 (AT & S) 21 March 1991 (21.03.91) 4 abstract. Υ EP 021225 A1 (SHIBAURA DENSHI) 7 January 1981 (07.01.81) 8,9 Further documents are listed in the continuation of Box C. See patent family annex. Special categories of cited documents: "T" later document published after the international filing date or priority ...A" document defining the general state of the art which is not date and not in conflict with the application but cited to understand considered to be of particular relevance the principle or theory underlying the invention .E" earlier application or patent but published on or after the international "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step tiling date ..L" document which may throw doubts on priority claim(s) or which is when the document is taken alone cited to establish the publication date of another citation or other "Y" document of particular relevance; the claimed invention cannot be special reason (as specified) considered to involve an inventive step when the document is ..O" document referring to an oral disclosure, use, exhibition or other combined with one or more other such documents, such combination being obvious to a person skilled in the art ..P" document published prior to the international filing date but later than "&" document member of the same patent family the priority date claimed Date of the actual completion of the international search Date of mailing of the international search report 30 March 2001 (30.03.2001) :6 March 2001 (16.03.2001) Name and mailing adress of the ISA/AT Authorized officer Austrian Patent Office

Form PCT/ISA/210 (second sheet) (July 1998)

Kohlmarkt 8-10; A-1014 Vienna

Facsimile No. 1/53424/535

INTERN NAL SEARCH REPORT Information on patent family members



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				AT	В	403527	25-03-1998

(19) World Intellectual Property Organization International Bureau



(43) International Publication Date 14 June 2001 (14.06.2001)

PCT

(10) International Publication Number WO 01/42775 A1

(51) International Patent Classification7:

G01N 27/12

(21) International Application Number: PCT/KR00/01440

(22) International Filing Date:

12 December 2000 (12.12.2000)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

1999/57196 13 December 1999 (1

13 December 1999 (13.12.1999) KR

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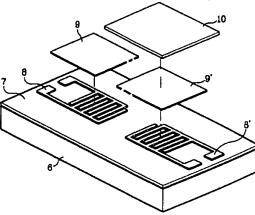
- (74) Agents: KIM, Yong, In et al.: 15th Floor, Yo Sam Bldg., 648-23, Yeoksam-dong, Kangnam-ku, Scoul 135-080 (KR).
- (81) Designated States (national): AE, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CR, CU, CZ, DE, DK, DM, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, TZ, UA, UG, US, UZ, VN, YU, ZA, ZW.
- (84) Designated States (regional): ARIPO patent (GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, Fl, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG).

Published:

With international search report.

[Continued on next page]

(54) Title: ABSOLUTE HUMIDITY SENSOR



(57) Abstract: An absolute humidity sensor for a microwave oven is disclosed. The absolute humidity sensor includes a silicon substrate, a humidity sensing element formed on a substrate, for detecting humidity exposed to the air, having a variable resistance value depending on the amount of the humidity, a temperature compensating element formed on the semiconductor, for compensating for the resistance value of the humidity sensing element, and a passivation film covered on the temperature compensating element, for shielding the humidity exposed to the air so as not to vary the resistance value of the temperature compensating element. The humidity sensing element and the temperature compensating element include an insulating film formed on the substrate, a humidity sensing film formed on the insulating film. For absorbing the humidity, and an electrode formed below the humidity sensing film or over/below the humidity sensing film. A polyimide thin film, which absorbs the humidity greater than a ceramic based humidity sensing material, is used as a humidity sensing material, and a silicon wafer is used as a substrate. Thus, an absolute humidity sensor susceptible to humidity can be fabricated and at the same time the sensor is integrated using a silicon process to facilitate its mass production.

VO 01/42775 A





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JC03 Rec'd PCT/PTO 1 3 AUG 2001

ABSOLUTE HUMIDITY SENSOR

Technical Field

The present invention relates to an absolute humidity sensor, and more particularly, to an absolute humidity sensor for a microwave oven.

Background Art

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Generally, a humidity sensor is used for various purposes, for example, in a hygrometer, a humidity sensor for cooking of food in a microwave oven, and the like. Examples of currently used humidity sensors include a capacitance type humidity sensor, a relative humidity sensor, and an absolute humidity sensor. The capacitance type humidity sensor is based on variation of dielectric constants by hygroscopic property of an organic material such as polyimide. The relative humidity sensor is based on resistance variation of a semiconductor ceramic such as MgCr₂O₄. The absolute humidity sensor is based on a ceramic thermistor.

Of the humidity sensors, the absolute humidity sensor based on two thermistors is widely used as a humidity sensor for cooking of food in a microwave oven.

The absolute humidity sensor has an advantage in that it can stably detect the humidity because it is not susceptible to variation of a peripheral temperature.

The principles of sensing humidity of the absolute humidity sensor in the microwave oven are based on resistance variation by temperature variation of a thermistor as vapor generated from food during cooking of

food absorbs heat of the thermistor.

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Fig. 1 shows a structure of a background art absolute humidity sensor. Referring to Fig. 1, two ceramic thermistors 1 and 2 coated with a passivation film such as a glass film are floating by being connected to a support pin 4 by a precious metal conductor 3 such as platinum. The ceramic thermistors 1 and 2 are packaged by a metal shield case 5 that isolates the two thermistors 1 and 2 from each other.

The thermistor 1 is exposed to the air to allow vapor to be in contact with a surface of the thermistor 1 by means of a fine hole of the metal shield case 5. The thermistor 1 is used as a sensing element. The other thermistor 2 is sealed in a dry N_2 by the metal shield case 5 so as not to be in contact with the vapor. The thermistor 2 is used as a reference element.

Therefore, if a bridge circuit consists of the two thermistors 1 and 2 and an external resistor, the vapor generated from food during cooking of food absorbs heat of the thermistor 1 exposed to the air. Thus, resistance variation occurs in only the exposed thermistor 1. In this case, output variation occurs due to a bias voltage, thereby detecting the humidity.

Since the background art humidity sensor uses an element as a ceramic thermistor, heat capacity is great and thus sensitivity is low.

Also, response time is slow and the size of the sensor becomes greater.

Furthermore, the thermistor element is floating using the conductor 3 and the support pin 4 as shown in Fig. 1, and the conductor 3 and the pin 4 are spot-welded. For assembly, the reference element 2 should be sealed in a dry N_2 . For this reason, the fabrication process

steps are complicate and the number of the process steps increases. Also, the cost is expensive and mass production is disadvantageous.

Disclosure of the Invention

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Accordingly, the present invention is directed to an absolute humidity sensor that substantially obviates one or more of the problems due to limitations and disadvantages of the background art.

An object of the present invention is to provide an absolute humidity sensor having excellent humidity hygroscopic property.

Another object of the present invention is to provide an absolute humidity sensor having simple process steps to facilitate mass production.

Additional features and advantages of the invention will be set forth in the description which follows, and in part will be apparent from the description, or may be learned by practice of the invention. The objectives and other advantages of the invention will be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings.

To achieve these and other advantages and in accordance with the purpose of the present invention, as embodied and broadly described, an absolute humidity sensor according to the present invention includes a silicon substrate, a humidity sensing element formed on a substrate, for detecting humidity exposed to the air, having a variable resistance value depending on the amount of the humidity, a temperature compensating element formed on the semiconductor, for compensating for the resistance value of the humidity sensing element, and a passivation film covered on

the temperature compensating element, for shielding the humidity exposed to the air so as not to vary the resistance value of the temperature compensating element.

In the preferred embodiment of the present invention, the humidity sensing element and the temperature compensating element include an insulating film formed on the substrate, a humidity sensing film formed on the insulating film, for absorbing the humidity, and an electrode formed below the humidity sensing film or over/below the humidity sensing film.

The insulating film and the passivation film are formed of any one of SiO_2 , Si_3N_4 , and SiO_xN_y . The humidity sensing film is formed of polyimide annealed at a temperature of $200\sim300\,^{\circ}\text{C}$. The electrode uses a comb electrode.

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The absolute humidity sensor according to the present invention further includes a printed circuit board joined with a lower portion of the silicon substrate, a wire which electrically connects electrodes of the humidity sensing element and the temperature compensating element with electrodes of the printed circuit board, and a metal shield case formed over the printed circuit board to cover an entire surface of the printed circuit board including the humidity sensing element and the temperature compensating element.

In the preferred embodiment of the present invention, a polyimide thin film, which absorbs the humidity greater than a ceramic based humidity sensing material, is used as a humidity sensing material, and a silicon wafer is used as a substrate. Thus, an absolute humidity sensor susceptible to humidity can be fabricated and at the same time the sensor

is integrated using a silicon process to facilitate its mass production.

It is to be understood that both the foregoing general description and the following detailed description are exemplary and explanatory and are intended to provide further explanation of the invention as claimed.

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Brief Description of the Drawings

The accompanying drawings, which are included to provide a further understanding of the invention and are incorporated in and constitute a part of this specification, illustrate embodiments of the invention and together with the description serve to explain the principles of the invention.

In the drawings:

Fig. 1 is a structural sectional view showing a background art of an absolute humidity sensor;

Figs. 2a and 2b are structural perspective views showing a resistance type absolute humidity sensor according to the present invention;

Figs. 3a and 3b are structural perspective views showing a capacitance type absolute humidity sensor according to the present invention;

Figs. 4a and 4b show a structure of an absolute humidity sensor package according to the present invention; and

Fig. 5 is a circuit diagram for detecting the humidity based on the resistance type absolute humidity sensor according to the present invention.

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Best Mode for Carrying Out the Invention

Reference will now be made in detail to the preferred embodiments of the present invention, examples of which are illustrated in the accompanying drawings.

First Embodiment

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Figs. 2a and 2b are structural perspective views showing a resistance type absolute humidity sensor according to the present invention.

As shown in Fig. 2a, an insulating film 7 of SiO_2 , Si_3N_4 , or SiO_xN_y is formed on a silicon substrate 6. A metal film such as Al or Pt is deposited on the insulating film 7 and then patterned to form a pair of electrodes 8 and 8' in a comb shape.

Afterwards, a polyimide thin film is spin-coated on the electrode and then patterned to form a humidity sensing film 9 for a humidity sensing element and a humidity sensing film 9' for a temperature compensating element.

The polyimide is imidized at a temperature of about 200°C or greater. The polyimide has a thermal decomposition temperature of about $450\sim500$ °C. Accordingly, the polyimide has excellent thermal stability.

Also, the polyimide has a hygroscopic property as follows.

An equilibrium value of an aqueous molecule absorbed into the polyimide at a room temperature under the ambient of a relative humidity ambient of 80% is about 2.3wt%. The polyimide absorbs humidity more than a ceramic based humidity sensing material. Moreover, a diffusion coefficient of the aqueous molecule within a polyimide thin film is approximately 5 x 10^{-9} cm²/sec at a room temperature. Accordingly, high

response time can be obtained.

The polyimide thin film has a compact film tissue when annealing is performed at a high temperature of about $300\,^{\circ}\mathrm{C}$ or greater. In this case, it is difficult to propagate the humidity into the film. To use the polyimide thin film as a humidity sensing element, the annealing process is preferably performed at a temperature between $200\,^{\circ}\mathrm{C}$ and $300\,^{\circ}\mathrm{C}$ to obtain high hygroscopic ratio of the polyimide film.

After the humidity sensing films 9 and 9' are formed, a ceramic thin film such as SiO_2 , Si_3N_4 , and SiO_xN_y is deposited on the humidity sensing film 9' for a temperature compensating element and then patterned, so that the humidity is not propagated into the humidity sensing film 9'. Thus, a passivation film 10 is formed.

In the resistance type absolute humidity sensor fabricated as above, it is noted that, as shown in Fig. 2b, the humidity sensing element and the temperature compensating element are formed on the same silicon substrate 6.

Second Embodiment

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Figs. 3a and 3b are structural perspective views showing a capacitance type absolute humidity sensor according to the present invention.

As shown in Fig. 3a, an insulating film 12 of SiO_2 , Si_3N_4 , or SiO_xN_y is formed on a silicon substrate 11. A metal film such as Al or Pt is deposited on the insulating film 12 and then patterned to form a lower electrode 13 for a humidity sensing element and a lower electrode 13' for a temperature compensating element.

Afterwards, a polyimide thin film is spin-coated on the lower

electrodes 13 and 13' and then patterned to form a humidity sensing film 14 for a humidity sensing element and a humidity sensing film 14' for a temperature compensating element. Subsequently, an annealing process is performed at a temperature between $200\,\mathrm{C}$ and $300\,\mathrm{C}$.

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The metal film having the same material as that of the lower electrodes 13 and 13' is deposited on the polyimide humidity sensing films 14 and 14' and then patterned to form an upper electrode 15 for a humidity sensing element and an upper electrode 15' for a temperature compensating element in a comb shape. Thus, a parallel capacitor structure is formed in such a manner that the polyimide humidity sensing film is formed between the upper and lower electrodes.

Unlike the lower electrodes 13 and 13', the upper electrodes 15 and 15' are formed in a comb shape to allow an aqueous molecule to smoothly pass through the polyimide humidity sensing film, thereby partially exposing the polyimide thin film.

Accordingly, the vapor is directly in contact with the polyimide humidity sensing film exposed between the upper electrodes, so as to be propagated into the thin film.

The polyimide has a relative dielectric constant of 3 to 4 at a room temperature. Also, the polyimide has a dissipation factor value of 0.001~0.003 at the frequency of 1kHz. Accordingly, the polyimide has a stable dielectric property.

In the present invention, since the polyimide humidity sensing film acts as a dielectric of a capacitor, dielectric mixtures having different dielectric constants are formed within the polyimide thin film if the aqueous molecule having a relative dielectric constant of 80 is

propagated into the polyimide thin film.

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Thus, the relative dielectric constant of the dielectric mixtures is varied depending on variation of the peripheral humidity, so that the humidity variation can be detected.

Finally, a ceramic thin film such as SiO_2 , Si_3N_4 , and SiO_xN_y is deposited on the humidity sensing film 14' for a temperature compensating element and the upper electrode 15' and then patterned, so that the humidity is not propagated into the humidity sensing film 14'. Thus, a passivation film 16 is formed.

In the capacitance type absolute humidity sensor fabricated as above, it is noted that, as shown in Fig. 3b, the humidity sensing element and the temperature compensating element are formed on the same silicon substrate 11.

Figs. 4a and 4b show a package structure of an absolute humidity sensor according to the present invention, in which one example of the resistance type absolute according to the first embodiment of the present invention is shown.

As shown in Fig. 4a, an absolute humidity sensor element 19 provided with a humidity sensing element 18 and a temperature compensating element 18 as fabricated by the method of the first embodiment is joined with a printed circuit board 20. Electrodes 8 and 8' of the elements are wire-bonded to an electrode 21 of the printed circuit board 20. Afterwards, as shown in Fig. 4b, a shield wire 22 is connected to the printed circuit board 20. The shield wire 22 and the printed circuit board 20 are sealed with a metal shield case 23 having a hole to propagate the humidity thereinto. Thus, the package of the absolute humidity sensor is

completed.

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Fig. 5 is a circuit diagram for detecting variation of the peripheral humidity based on the resistance type absolute humidity sensor according to the present invention. The circuit for detecting variation of the peripheral humidity includes a bridge circuit and a power source V applied to the bridge circuit. The bridge circuit consists of a humidity sensing element 17, a temperature compensating element 18, a fixed resistor R1, and a variable resistor VR.

As an example, a method for detecting variation of the humidity by the water vapor generated from food during cooking of food in a microwave oven using the absolute humidity sensor and the above circuit will be described below.

First, if the food is heated in the microwave oven, the water vapor is generated. The generated water vapor is propagated into the metal shield case 23 through the hole formed therein. Thus, the water vapor is in contact with the humidity sensing element 17 and the temperature compensating element 18.

At this time, the humidity sensing element 17 has a varied resistance as the humidity is absorbed in the polyimide. However, the temperature compensating element 18 does not have a varied resistance as the humidity is not absorbed in the polyimide due to the passivation film.

The resistance variation of the humidity sensing element 17 causes output variation of the bridge circuit, thereby detecting the humidity variation.

Accordingly, the humidity variation around the sensor can easily be detected by the absolute humidity sensor and the above circuit. The water

vapor generated from the food due to heat during cooking of food in a cooking machine such as a microwave oven is detected to apply for automatic cooking of food.

Industrial Applicability 5

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As aforementioned, the absolute humidity sensor according to the present invention has the following advantages.

The polyimide thin film, which absorbs the humidity greater than a ceramic based humidity sensing material, is used as a humidity sensing material, and a silicon wafer is used as a substrate. Thus, an absolute humidity sensor susceptible to humidity can be fabricated and at the same time the sensor can be integrated using a silicon process. This simplifies the package process and facilitates mass production of the sensor.

The foregoing embodiments are merely exemplary and are not to be 15 construed as limiting the present invention. The present teachings can be readily applied to other types of apparatuses. The description of the present invention is intended to be illustrative, and not to limit the scope of the claims. Many alternatives, modifications, and variations will be apparent to those skilled in the art.

What is claimed is:

- 1. An absolute humidity sensor comprising:
- a silicon substrate;
- a humidity sensing element formed on a substrate, for detecting humidity exposed to the air, having a variable resistance value depending on the amount of the detected humidity;
 - a temperature compensating element formed on the semiconductor, for compensating for the resistance value of the humidity sensing element; and
- a passivation film covered on the temperature compensating element, for shielding the humidity exposed to the air so as not to vary the resistance value of the temperature compensating element.
- 2. The absolute humidity sensor of claim 1, wherein the humidity sensing element and the temperature compensating element include:
 - an insulating film formed on the substrate;
 - a humidity sensing film formed on the insulating film, for absorbing the humidity; and
- an electrode formed below the humidity sensing film or over/below the humidity sensing film.
 - 3. The absolute humidity sensor of claim 2, wherein the insulating film is formed of any one of SiO_2 , Si_3N_4 , and SiO_xN_y .

4. The absolute humidity sensor of claim 2, wherein the humidity sensing film is formed of polyimide.

5. The absolute humidity sensor of claim 2, wherein the electrode has a comb shape.

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- 6. The absolute humidity sensor of claim 2, wherein the electrode formed only over the humidity sensing film has a comb shape.
- 7. The absolute humidity sensor of claim 1, wherein the passivation film is formed of any one of SiO_2 , Si_3N_4 , and SiO_xN_y .
- 8. The absolute humidity sensor of claim 1, further comprising:

 a printed circuit board joined with a lower portion of the silicon substrate;
 - a wire for electrically connecting electrodes of the humidity sensing element and the temperature compensating element with electrodes of the printed circuit board; and
- a metal shield case formed over the printed circuit board to cover an entire surface of the printed circuit board including the humidity sensing element and the temperature compensating element.
- 9. The absolute humidity sensor of claim 8, wherein the metal shield case has a hole for propagation of external humidity.